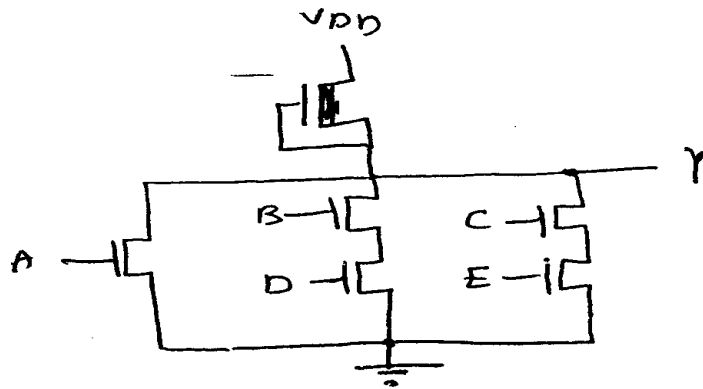


COE 360, Principles of VLSI Design, Term 071
HW# 5

- Q.1.** Consider a resistive-load inverter with $V_{DD}=5V$, $V_{tn} = 0.8 v$, and $R_L=120 K\Omega$. Suppose that the average DC power dissipation of the inverter is $100 \mu W$. Determine the values of V_{IL} and $V_{out}(V_{IL})$.
- Q.2.** Consider the depletion-load gate shown below with the following parameters: $V_{tn}=1.0 V$, $V_{td}=-2.5 V$, $\mu_n C_{ox}=100 \text{ uA/V}^2$, $V_{DD}=5 V$, $\gamma=0.4 V^{1/2}$, $2\phi_b = 0.6 V$, and $(W/L)_{load}=1/3$.
- (i) Assuming $(W/L)_A=2$, $(W/L)_B=4$, $(W/L)_C=3$, $(W/L)_D=6$, and $(W/L)_E=5$, compute the best and worst V_{OL} .
- (ii) Design the circuit (i.e. determine the W and L for the transistors) to achieve $V_{OL}=0.1V$ (Hint: you need to consider worst case).



- Q.3.** A CMOS fabrication process has the following parameters:
 $\mu_n C_{ox}=100 \text{ uA/V}^2$, $\mu_p C_{ox}=40 \text{ uA/V}^2$, $V_{DD}=5 V$, $\gamma=0.4 V^{1/2}$, $2\phi_b = 0.6 V$,
 $L=1\mu m$ for both nMOS and pMOS devices and $W= 2 \mu m$ for pMOS devices,
 $V_{tn}=1.0 V$, $V_{tp}=-1.0 V$.
- (i) Design a CMOS inverter such that $V_{th}=2.5V$ for $V_{DD}=5V$.
- (ii) Compute the NM_H and NM_L for the inverter.
- Q.4.** Using spice, draw a family of voltage transfer characteristics of the depletion-load NMOS inverters having $(W/L)_{pullup}=1/2$ and pulldown transistors with $(W/L)_{pulldown}=1/1$, $2/1$, and $4/1$ respectively. Use the parameters given in Q1 for the transistors (except W and L). What are your observations ?
- Q.5.** Using spice, draw a family of voltage transfer characteristics of the CMOS inverters having $(W/L)_{pullup}=2/1$ and pulldown transistors with $(W/L)_{pulldown}=1/1$, $2/1$, and $4/1$ respectively. Use the parameters given in Q2 for the transistors (except W and L). What

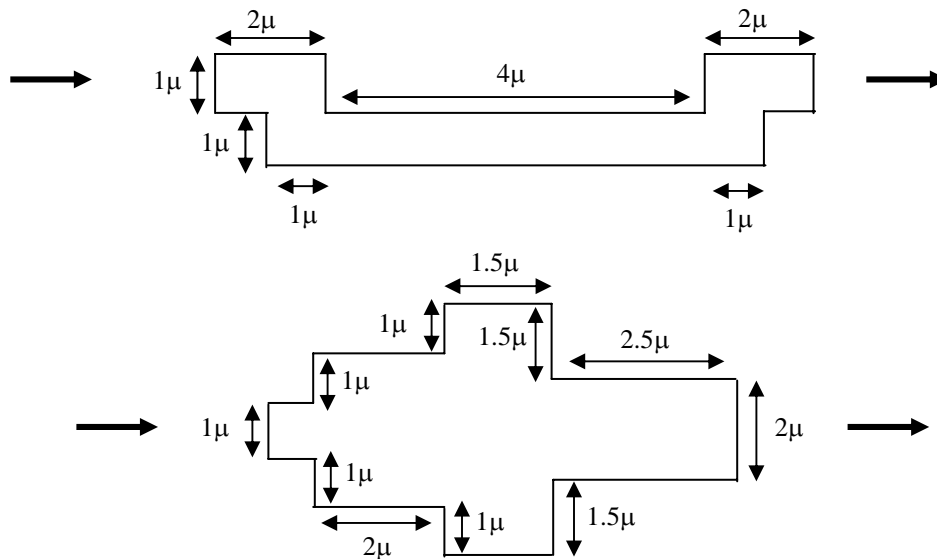
are your observations, and what are the major differences with the VTC of the NMOS inverters in Q3 ?

Q.6. In a standard single metal N-Well CMOS fabrication process, the sheet resistances of various layers are given below:

<i>p-channel:</i>	15×10^3	Ω/SQ
<i>n-channel:</i>	6×10^3	Ω/SQ
<i>polysilicon:</i>	20	Ω/SQ
<i>n-diffusion:</i>	40	Ω/SQ
<i>p-diffusion:</i>	150	Ω/SQ
<i>Metal:</i>	0.05	Ω/SQ

Since the current flow in corner squares is not uniform, it is assumed that the value of a corner square is equal to 0.66 the normal square resistance.

(i) Calculate the resistance of the following shapes for each of the polysilicon, n-diffusion, p-diffusion, and metal material types.



(ii) Calculate the channel resistance of the following transistors.

